

HMC369LP3 / 369LP3E

v04.0210



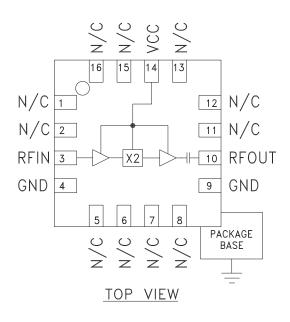
SMT GaAs HBT MMIC x2 ACTIVE FREQUENCY MULTIPLIER, 9.9 - 12.7 GHz OUTPUT

Typical Applications

Active Multiplier for X Band Applications:

- OC-192 Clock Recovery
- Microwave Radio & VSAT
- Military Radios, Radar & ECM
- Test Instrumentation

Functional Diagram



Features

Output Power: +4 dBm

Sub-Harmonic Suppression: 30 dBc SSB Phase Noise: -142 dBc/Hz

Single Supply: 5V@ 46 mA

16 Lead 3x3mm SMT Package: 9mm²

General Description

The HMC369LP3 & HMC369LP3E are active miniature x2 frequency multipliers utilizing InGaP GaAs HBT technology in 3x3 mm leadless QFN surface mount packages. Power output is +4 dBm typical from a single +5V supply and varies little vs. input power, temperature and supply voltage. Suppression of undesired fundamental and sub-harmonics is 30 dBc typical with respect to output signal level. The low additive SSB phase noise of -142 dBc/Hz at 100 kHz offset helps the user maintain good system noise performance. The HMC369LP3(E) is ideal for use in LO multiplier chains allowing reduced parts count versus traditional approaches. The HMC-369LP3(E) are also useful for OC-192 clock recovery. The application of 10 GBPS data to the input generates a -7 dBm clock tone at the output with spurious signals suppressed by 25 dB.

Electrical Specifications, $T_A = +25^{\circ}$ C, Vcc = 5V

Parameter		Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, Input		4.95 - 5.3			5.3 - 6.35			GHz
Frequency Range, Output		9.9 - 10.6		10.6 - 12.7			GHz	
Input Power Range		-5		+5	-5		+5	dBm
Output Power		-1	3		0	4		dBm
Sub-Harmonic Suppression			30			30		dBc
Input Return Loss			17			16		dB
Output Return Loss			5.5			6		dB
SSB Phase Noise (100 kHz Offset) Pin:	= 0 dBm		-142			-142		dBc/Hz
Supply Current (Icc)			46	61		46	61	mA

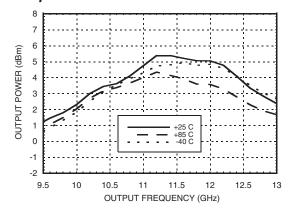


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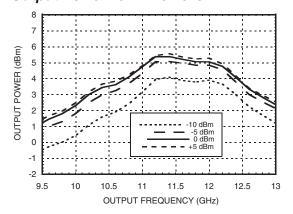


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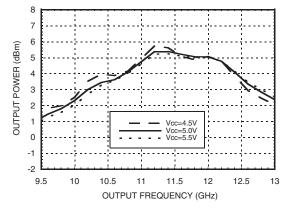
Output Power vs. Temperature @ 0 dBm Drive Level



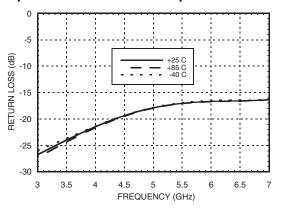
Output Power vs. Drive Level



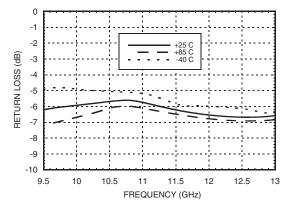
Output Power vs. Supply Voltage @ 0 dBm Drive Level



Input Return Loss vs. Temperature



Output Return Loss vs. Temperature





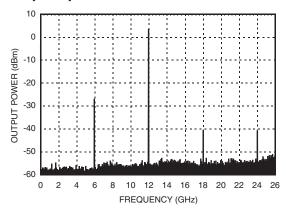
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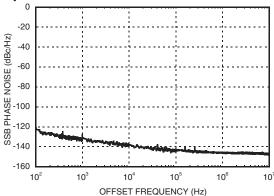


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Output Spectrum



SSB Phase Noise Performance, Fout= 10.66 GHz, Input Power= 0 dBm





RoHS V

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Absolute Maximum Ratings

+20 dBm
+5.5V
135 °C
440 mW
147.8 °C/W
-65 to +150 °C
-40 to +85 °C

Typical Supply Current vs. Vcc

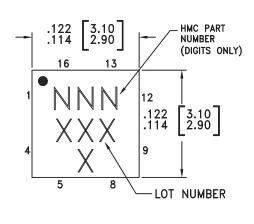
Vcc (V)	Icc (mA)
4.5	45
5.0	46
5.5	47

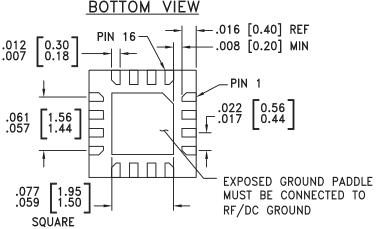
Note: Multiplier will operate over full voltage range shown above.

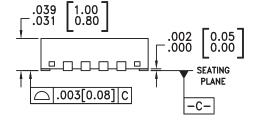


ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Outline Drawing







NOTES

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.
 PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC369LP3	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	369 XXXX
HMC369LP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	3 <u>69</u> XXXX

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX



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Pin Description

Pin Number	Function	Description	Interface Schematic
1, 2, 5 - 8, 11 - 13, 15, 16	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
3	RFIN	RF input needs to be DC blocked only if there is an external DC voltage applied to RFIN.	RFIN ○
4, 9	GND	All ground leads and ground paddle must be soldered to PCB RF/DC ground.	= O GND
10	RFOUT	Multiplied Output. AC coupled. No external DC blocks necessary.	— —○ RFOUT
14	Vcc	Supply voltage 5V ± 0.5V.	